MA22D39

Silicon epitaxial planar type

For high speed switching circuits

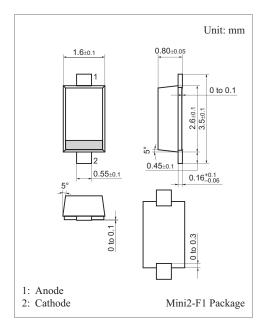
■ Features

- ullet Optimum for forward current (Effective value) $I_{F(RMS)} = 1.57$ A rectification
- \blacksquare Reverse voltage $V_{Rl} = 40 \text{ V}$ is guaranteed

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Reverse voltage	V_R	40	V	
Maximum peak reverse voltage	V_{RM}	40	V	
Forward current (Effective value) *1	I _{F(RMS)}	1.57	A	
Non-repetitive peak forward surge current *2	I_{FSM}	30	A	
Junction temperature	T _j	150	°C	
Storage temperature	T _{stg}	-55 to +150	°C	

Note) *1: Mounted on an alumina PC board



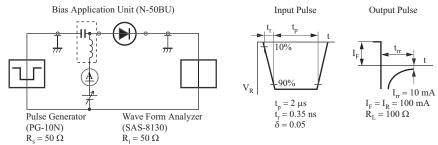
Marking Symbol: 3N

■ Electrical Characteristics $T_a = 25$ °C±3°C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	V_{Fl}	$I_F = 0.5 A$			0.48	V
	V_{F2}	$I_F = 1.1 \text{ A}$			0.54	
	V_{F3}	$I_F = 1.5 A$			0.57	
Reverse current	I_R	$V_{R^l} = 40 \text{ V}$			100	μΑ
Terminal capacitance	C_{t}	$V_{RJ} = 10 \text{ V, } f = 1 \text{ MHz}$		50		pF
Reverse recovery time *	t _{rr}	$I_F = I_{Rl} = 100 \text{ mA}, I_m = 10 \text{ mA},$ $R_{Ll} = 100 \Omega$		30		ns

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

- 2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
- 3. *: t_{rr} measurement circuit



^{*2: 50} Hz sine wave 1 cycle (Non-repetitive peak current)

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